

2.0x1.25mm SMD CHIP LED LAMP

Part Number: APT2012LZGCK Green



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

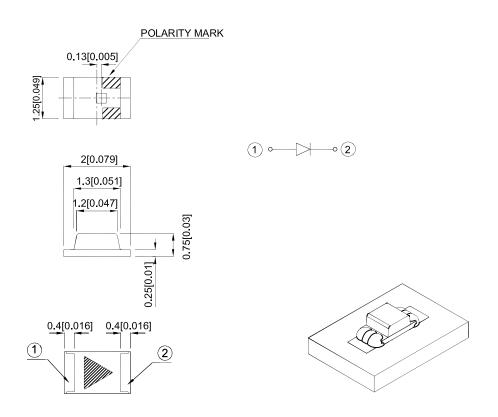
Features

- 2.0mm x1.25mm SMT LED,0.75mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Low current IF=2mA operating.
- RoHS compliant.

Descriptions

- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions



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- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 2mA		Viewing Angle [1]
		2.	Min.	Тур.	201/2
APT2012LZGCK	Green (InGaN)	Water Clear	20	50	120°

- 1. 01 / 2 is the angle from optical centerline where the luminous intensity is 1 / 2 of the optical peak value.
 2. Luminous intensity / luminous Flux: + / -15%.
 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Min.	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green		515		nm	IF=2mA
λD [1]	Dominant Wavelength	Green		525		nm	IF=2mA
Δλ1/2	Spectral Line Half-width	Green		35		nm	IF=2mA
С	Capacitance	Green		45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	2.2	2.65	3	V	IF=2mA
lr	Reverse Current	Green			50	uA	V _R =5V

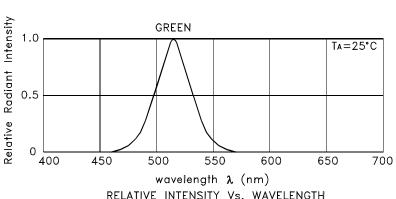
- Notes:
 1. Wavelength: + / -1nm.
 2. Forward Voltage: + / -0.1V.
 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units		
Power dissipation	75	mW		
DC Forward Current	25	mA		
Peak Forward Current [1]	150	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

1. 1 / 10 Duty Cycle, 0.1ms Pulse Width.

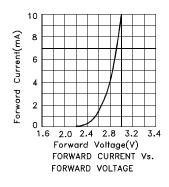
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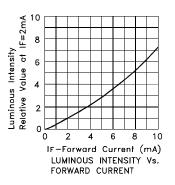


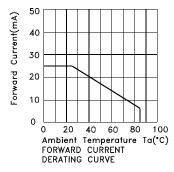
RELATIVE INTENSITY Vs. WAVELENGTH

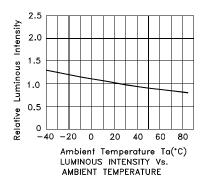
Green

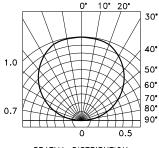
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SPATIAL DISTRIBUTION

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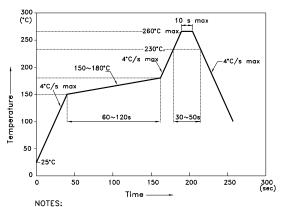
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

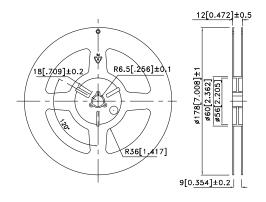
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



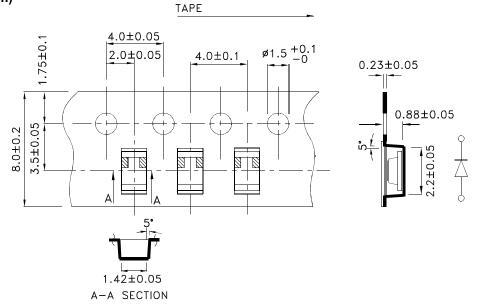
Reel Dimension



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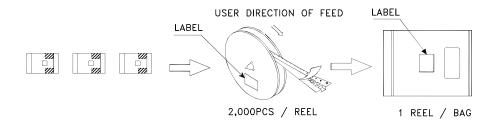
Tape Dimensions (Units: mm)

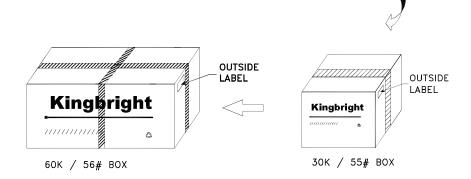


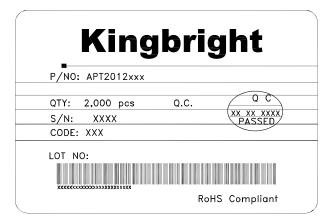
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PACKING & LABEL SPECIFICATIONS

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